

**Product data sheet** 

## **1. General description**

Planar passivated high commutation three quadrant triac in a SOT54 (TO-92) plastic package. This "series DN" triac balances the requirements of commutation performance and gate sensitivity and is intended for interfacing with low power drivers and logic ICs including microcontrollers.

## 2. Features and benefits

- 3Q technology for improved noise immunity
- Direct gate triggering from low power drivers and logic ICs
- High commutation capability with very sensitive gate
- High voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Triggering in three quadrants only
- Very sensitive gate for easy logic level triggering

## **3. Applications**

- Low power motor controls
- Small inductive loads e.g. solenoids, door locks, water valves
- Small loads in large white goods

## 4. Quick reference data

### Table 1. Quick reference data

Symbol	Parameter	Conditions	Values	Unit
Absolute	maximum rating		·	
$V_{\text{DRM}}$	repetitive peak off-state voltage		1000	V
I <sub>T(RMS)</sub>	RMS on-state current	square-wave pulse; T <sub>lead</sub> ≤ 57 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	0.8	A
I <sub>TSM</sub>	non-repetitive peak forward current	full sine wave; $t_p$ = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	9	A
		full sine wave; $t_p$ = 16.7 ms; $T_{j(init)}$ = 25 °C	9.9	А
Tj	junction temperature		125	°C

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· · · · ·				
I <sub>GT</sub>	gate trigger current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G+} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	0.25	-	5	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G-} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	0.25	-	5	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G-} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	0.25	-	5	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-	10	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 0.85 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
Dynamic	characteristics	· ·				
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 670 V; T <sub>j</sub> = 125 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit	-	150	-	V/µs
dI <sub>com</sub> /dt	rate of change of commutating current	$V_D$ = 400 V; T <sub>j</sub> = 125 °C; I <sub>T(RMS)</sub> = 0.8 A; dV <sub>com</sub> /dt = 10 V/µs; gate open circuit;	0.5	-	-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 0.8 \text{ A}; dV_{com}/dt = 1 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	1	-	-	A/ms

# 5. Pinning information

Table 2.	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	T2	main terminal 2		T2T1				
2	G	gate	Line Line Line Line Line Line Line Line	G sym051				
3	T1	main terminal 1	0 (1 (1) 0 0 0 0 0 0 0 0 0 0 0 0 0	Symoor				

# 6. Ordering information

### Table 3. Ordering information

Type number	Package	Package					
	Name	Description	Version				
BTA2008-1000DN	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54				

## 7. Marking

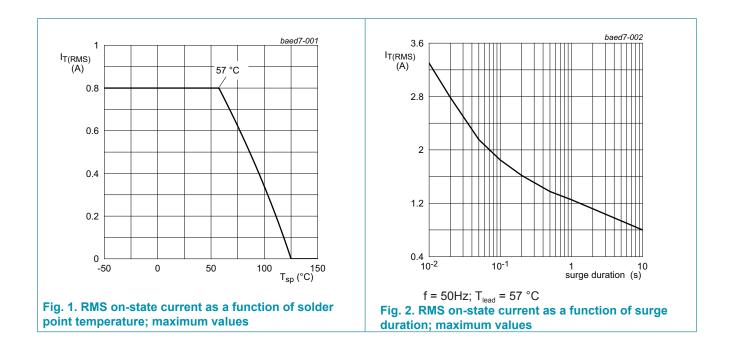
Table 4. Marking codes			
Type number		Marking codes	
BTA2008-1000DN		BTA2008-1000DN	
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# 8. Limiting values

### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

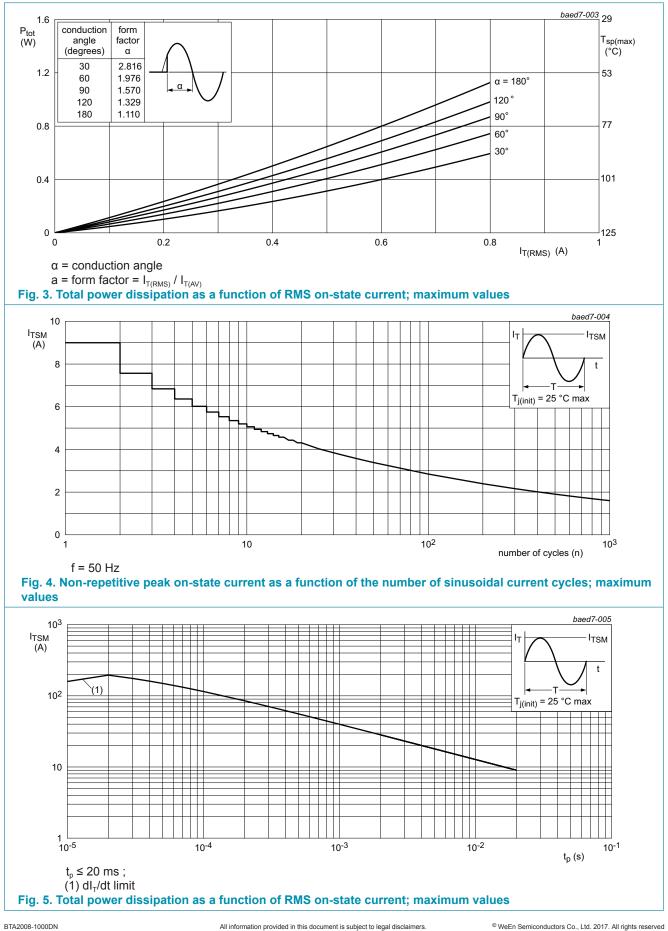
Symbol	Parameter	Conditions	Values	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage		1000	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>lead</sub> ≤ 57°C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u>	0.8	A
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; $t_p$ = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	9	A
		full sine wave; $t_p$ = 16.7 ms; $T_{j(init)}$ = 25 °C	9.9	А
l <sup>2</sup> t	l <sup>2</sup> t for fusing	t <sub>p</sub> = 10ms; sine wave	0.41	A²/s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 10mA	100	A/µs
I <sub>GM</sub>	peak gate current		1	А
P <sub>GM</sub>	peak gate power		2	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	0.1	W
T <sub>stg</sub>	storage temperature		-40 to 150	°C
T <sub>j</sub>	junction temperature		125	°C



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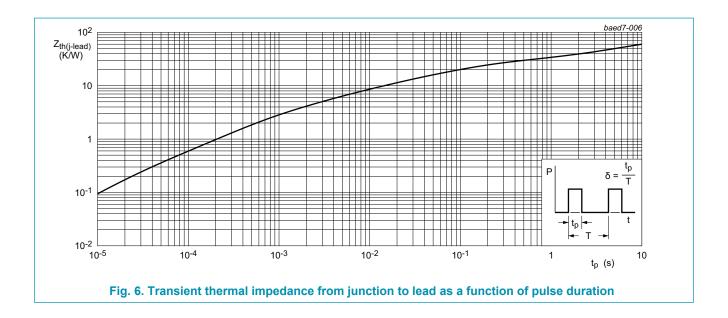
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## 9. Thermal characteristics

Table 5. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	<u>Fig. 6</u>		-	-	60	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	in free air		-	150	-	K/W



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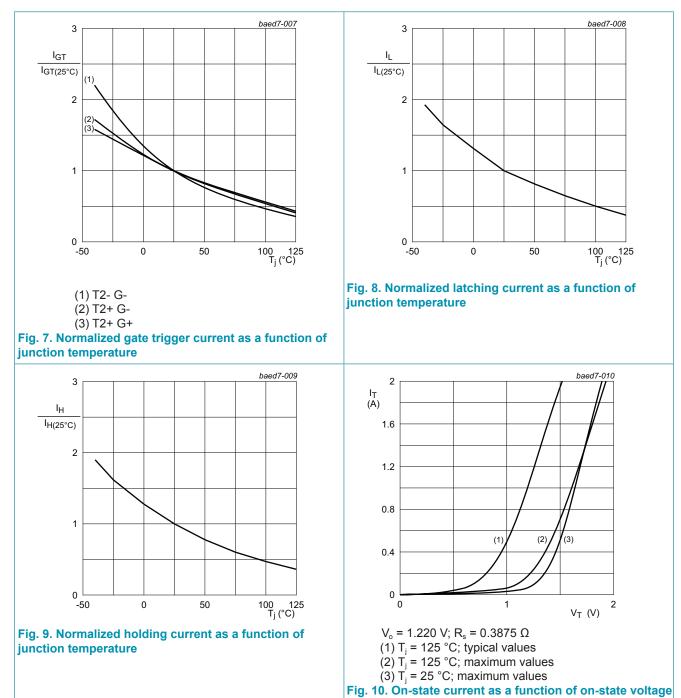
## **10. Characteristics**

	aracteristics						
Symbol	Parameter	Conditions	Mi	n T	ӯҏ	Max	Unit
Static cha	racteristics						
I <sub>GT</sub>	gate trigger current	$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G+; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	0.2	25 -		5	mA
		$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G-; T <sub>j</sub> = 25 °C; Fig. 7	0.2	25 -		5	mA
		$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2- G-; T <sub>j</sub> = 25 °C; Fig. 7	0.2	25 -		5	mA
IL	latching current	$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G+; T <sub>j</sub> = 25 °C; Fig. 8	-	-		10	mA
		$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G-; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	-	-		20	mA
		$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2- G-; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	-	-		10	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-		10	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 0.85 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1	.3	1.6	V
V <sub>gt</sub>	gate trigger voltage	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T}_{j} = 25 \text{ °C};$ Fig. 11	-	0	.85	1	V
		V <sub>D</sub> = 400 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 125 °C; Fig. 11	0.2	2 0	.3	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 1000 V; T <sub>j</sub> = 25 °C	-	-		10	μA
		V <sub>D</sub> = 1000 V; T <sub>j</sub> = 125 °C	-	0	.1	0.5	mA
Dynamic c	haracteristics	· · · · · ·				1	
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 670 V; T <sub>j</sub> = 125 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit	-	1	50	-	V/µs
dI <sub>com</sub> /dt	rate of change of commutating current	$\label{eq:V_D} \begin{array}{l} V_{\text{D}} = 400 \text{ V};  \text{T}_{\text{j}} = 125 ^{\circ}\text{C};  \text{I}_{\text{T(RMS)}} = 0.85 \text{ A}; \\ \text{d} \text{V}_{\text{com}} / \text{d} \text{t} = 10  \text{V} / \mu \text{s}; \text{ gate open circuit} \end{array}$	0.9	5 -		-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 0.85 \text{ A};$ $dV_{com}/dt = 1 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	1	-		-	A/ms

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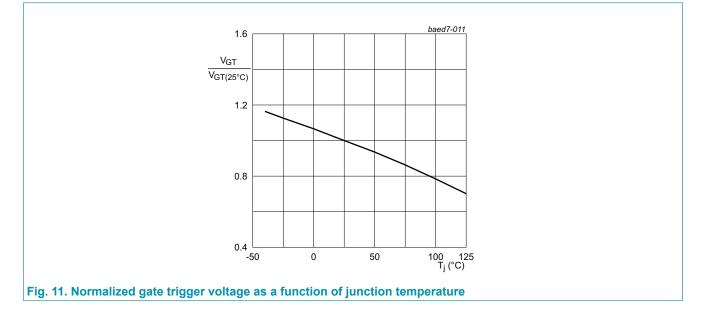
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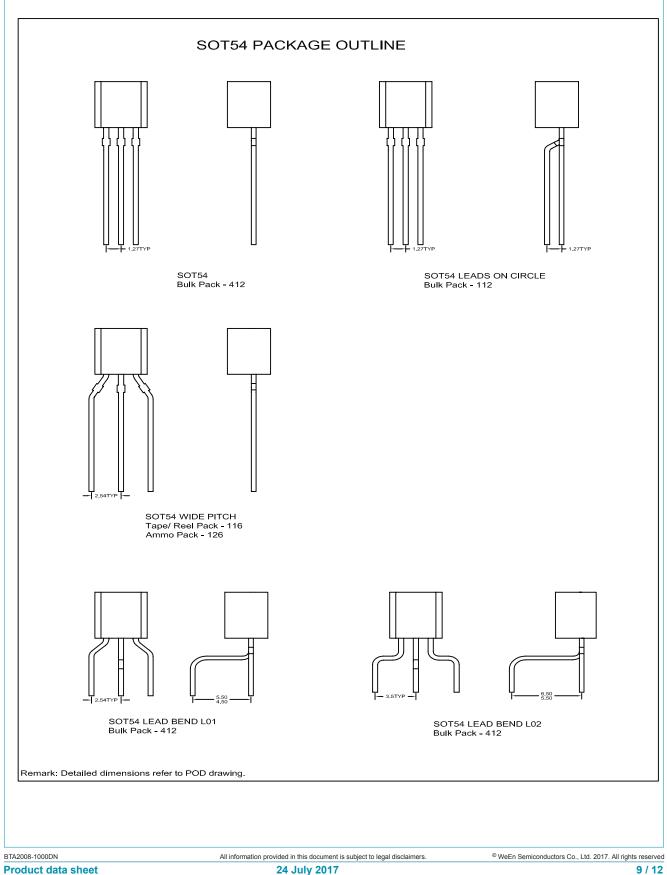
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# 11. Package outline



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# 12. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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